

新北市汐止區新台五路一段81號10樓之六 10F-6, No.81, Sec.1, Xintai 5th Rd., Xizhi-Dist., New Taipei City 221, Taiwan, R.O.C. TEL 886 2 2698 7028 FAX 886 2 2698 7078 WEBSITE www.attend.com.tw

SPECIFICATION AND PERFORMANCE

Series	119A-XXA00-R02	File	119A-XXA00-R02_spec_4	Date	2020/04/16	
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Scope:

This specification covers the requirements for product performance, test methods and quality assurance provisions of below table

P/N	Description
119A-40A00-R02	Mini PCI Express Socket, GF, Reel, H=4.0mm, (w/Logo)
119A-56A00-R02	Mini PCI Express Socket, GF, Reel, H=5.6mm, (w/Logo)
119A-80A00-R02	Mini PCI Express Socket, GF, Reel, H=8.0mm, (w/Logo)
119A-92A00-R02	Mini PCI Express Socket, GF, Reel, H=9.2mm, (w/Logo)

Performance and Descriptions:

The product is designed to meet the electrical, mechanical and environmental performance requirements specification. Unless otherwise specified, all tests are performed at ambient environmental conditions.

RoHS:

All material in according with the RoHS environment related substances list controlled.

	MATERIALS								
NO.	NO. PART NAME DESCRIPTION								
1	HOUSING	LCP MG350, UL94V-0, Black							
2	CONTACT	Phosphor Bronze, C5191 Contact Area: Gold Flash, solder area: 100u" matte Tin, all under plated 50u" Nickel							
3	HOLD DOWN	Brass, C2680, Solder area: 100u" matte Tin plated, under plated 50u" Nickel							

RATING					
Rated Voltage	50V AC				
Rated Current	0.5A				
Operating Temperature	-40°C to +85°C				
Storage Temperature	-40°C to +85°C				
Durability	50 cycles				

ELECTRICAL									
Item	Item Requirement Test Condition								
Contact Resistance	Initial: $30m\Omega$ Max. After test $20m\Omega$ change max.	Solder connectors on PCB and mate them together, measure by applying closed circuit current of 100mA							

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		maximum at open circuit voltage of 20mV (max). (JIS C5402 5.4)
Insulation Resistance	Initial: 500Ω Min. After: $100M\Omega$ Min.	Apply 500V DC between adjacent contacts, or contact and ground. (MIL-STD-202 METHOD 302)
Dielectric Withstanding Voltage	No breakdown	Mate connectors; apply 250V AC at 60Hz (rms.) between two adjacent for 1 minute. (Trip current: 0.5mA) (MIL-STD-202 METHOD 301)

	MECHANICAL								
Item	Requirement	Test Condition							
Contact Normal Force	50gf per pin Min.	The normal force of the individual contact shall be 50 gf minimum							
Contact Retention Force	180gf per pin Min.	Place a connector on the push-pull machine, then apply a force on a contact head and push the contact to the opposite direction of the contact insertion at the speed of 25±3mm/min. (EIA364-29)							
Durability	Finish 1.Contact Resistance: 50mΩ Max. 2.No Damage	After 50 mating and un-mating cycles with 1.0mm thick board at the rate of 25±3mm/min. The connector shall be of no damage to the housing or contacts. The connector shall also meet the requirements of contact resistance in the paragraph 5.1 (EIA364-09)							
Shock	Finish 1. No electrical discontinuity more than 0.1μs. 2. No Damage 3. Contact Resistance: 50mΩ Max.	Solder connectors on PCB and mate them together, subject to following shock conditions, 3 shocks shall be period along 3 mutually perpendicular axis, passing DC 1mA current during the test. 50G,11ms Half-sine							



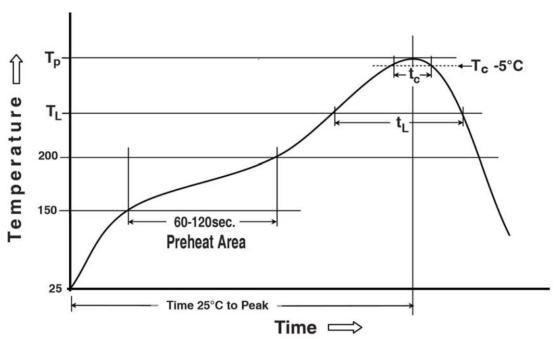
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	(MIL-STD-202 METHOD 213)

ENVIRONMENTAL								
Item	Requirement		Test Condition					
Humidity Test	Finish Humidity storage at $40\pm3^{\circ}$ C with 1. Contact Resistance: $90\pm5\%$ RH for 96 hours. $50m\Omega$ Max.							
	2. Insulation Resistance: $100M\Omega$ Min.	sistance: (EIA364-31)						
Salt Mist Test	Finish $5\pm1\%$ salt solutions, at $35\pm2^{\circ}$ C 1. Contact Resistance: duration 24 hours. Connectors detached 2. No Damage (MIL-STD-1344)							
Thermal Shock	Finish	Stage	Temp	Time				
	1. Contact Resistance:	t1	-55±5°C	30 min				
t3	50mΩ Max.	t2	-55±5°C~+85±5°C	5 min				
t2/ \t4	2. Insulation Resistance:	t3	+85±5°C	30 min				
	100MΩ Min.	t4	+85±5°C~-55°C±5°C	5 min				
t1		Test time: 5 cycles (MIL-STD-202 METHOD 107)						
Heat Resistance	Finish	Solder	connectors on PCB and	d mate				
	1. Contact Resistance:	them t	ogether, expose to 85±	±2°C for				
	50mΩ Max.	48hrs.	Upon completion of the	e exposure				
	2. Insulation Resistance:	period	the test specimens sh	all be				
	100MΩ Min.	conditioned at ambient room conditions						
		for 1 of 2hrs, after which the specified						
		measurements shall be performed.						
		(MIL-S	TD-202 METHOD 108)					

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	SOLDER ABILITY								
Solderability	95% of immersed area must show no voids , pin holes	Dip solder tails into the molten							
		solder(held at 230±5 °C) up to							
		0.5mm from the tip of tails for 3±0.5							
		seconds.							
		(MIL-STD-202 METHOD 208)							
Resistance to soldering heat	No melting, cracks or functional	All connectors designed for PCB							
	damage allowed	soldering within this specification must							
		be able to withstand the heat from							
		solder oven according to the graph							
		below. The cycle should be repeated							
		twice.							
		(MIL-STD-202 METHOD 210)							



Preheating temperature: $150 \sim 200^{\circ}$ C, $60 \sim 120$ seconds Liquidus temperature (TL): 217° C, $60 \sim 150$ seconds

Peak temperature: 260°C

Time within 5 °C of peak temperature (Tc): 255°C, 30seconds



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	TEST SEQUENCE										
No.	Test Item	Α	В	С	D	Е	F	G	Н	I	J
1	Contact Resistance			1,3	1,3	1,3	1,3	1,4	1,3		
2	Insulation Resistance							2,5			
3	Dielectric Withstanding Voltage										
4	Contact Normal Force	1									
5	Contact Retention Force		1								
6	Durability Life			2							
7	Shock				2						
8	Temperature Shock					2					
9	Heat Resistance						2				
10	Humidity							3			
11	Salt Spray								2		
12	Solder ability									1	
13	Resistance to Soldering Heat										1
	Sample Quantity	4	4	4	4	4	4	4	4	4	4

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